

## SC040N120Y4

68 Amps, 1200 Volts N-Channel Sic Power MOSFET

### Features

- 68A,1200V, $R_{DS(ON)MAX}=53m\Omega$  @ $V_{GS}=18V/33.3A$
- High Blocking Voltage with low On-Resistance
- High Speed Switching with Low Capacitance
- Easy to Parallel and Simple to Drive

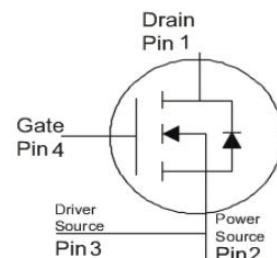
### Benefits

- Higher System Efficiency
- Reduced Cooling Requirements
- Increased Power Density
- Increased System Switching Frequency

### Applications

- Renewable Energy
- EV Battery Chargers
- High Voltage DC/DC Converters
- Switch Mode Power Supplies

TO-247-4L



### Absolute Maximum Ratings ( $T_c=25^\circ C$ , unless otherwise noted)

Parameter	Symbol	Value	UNIT	Test Conditions
Drain-Source Voltage	$V_{DSmax}$	1200	V	$V_{GS}=0V, I_{DS}=100\mu A$
Gate-Source Voltage(dynamic)	$V_{GSmax}$	-8/+22		Absolute maximum values
Gate-Source Voltage (static)	$V_{GSop}$	-4/+18		Recommended operational values
Continuous Drain Current	$I_D$	68	A	$V_{GS}=18V, T_c=25^\circ C$
		49		$V_{GS}=18V, T_c=100^\circ C$
Pulsed Drain Current	$I_{D(pulse)}$	100	A	Pulse width $t_p$ limited by $T_{Jmax}$
Power Dissipation	$P_D$	340	W	$T_c=25^\circ C, T_J=150^\circ C$
Operating Junction and Storage Temperature Range	$T_J, T_{STG}$	-55 to +175	°C	

### Thermal Characteristics

Parameter	Symbol	SC040N120Y4	Units
Maximum Junction-to-Case	$R_{thJC}$	0.44	°C/W

### Electrical Characteristics ( $T_c=25^\circ\text{C}$ ,unless otherwise noted)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Drain-Source Breakdown Voltage	$\text{BV}_{\text{DSS}}$	$\text{V}_{\text{GS}}=0\text{V}, \text{I}_D=100\text{uA}$	1200	—	—	V
Zero Gate Voltage Drain Current	$\text{I}_{\text{DSS}}$	$\text{V}_{\text{DS}}=1200\text{V}, \text{V}_{\text{GS}}=0\text{V}$	—	1	100	$\mu\text{A}$
Gate-Body Leakage Current,Forward	$\text{I}_{\text{GSSF}}$	$\text{V}_{\text{GS}}=22\text{V}, \text{V}_{\text{DS}}=0\text{V}$	—	10	250	nA
Gate-Body Leakage Current,Reverse	$\text{I}_{\text{GSSR}}$	$\text{V}_{\text{GS}}=-8\text{V}, \text{V}_{\text{DS}}=0\text{V}$	—	10	250	nA
Gate-Source Threshold Voltage	$\text{V}_{\text{GS(th)}}$	$\text{V}_{\text{DS}}=\text{V}_{\text{GS}}, \text{I}_D=9.5\text{mA}$	1.9	2.6	4.0	V
Drain-Source On-State Resistance	$\text{R}_{\text{DS(on)}}$	$\text{V}_{\text{GS}}=18\text{V}, \text{I}_D=33.3\text{A}$	—	40	53	$\text{m}\Omega$
		$\text{V}_{\text{GS}}=18\text{V}, \text{I}_D=33.3\text{A}, T_j=175^\circ\text{C}$	—	65	—	
Input Capacitance	$\text{C}_{\text{iss}}$	$\text{V}_{\text{DS}}=1000\text{V},$ $\text{V}_{\text{GS}}=0\text{V},$ $f=1.0\text{MHz},$ $\text{V}_{\text{AC}}=25\text{mV}$	—	2070	—	pF
Output Capacitance	$\text{C}_{\text{oss}}$		—	112	—	pF
Reverse Transfer Capacitance	$\text{C}_{\text{rss}}$		—	11	—	pF
Coss Stored Energy	$\text{E}_{\text{oss}}$		—	66	—	$\mu\text{J}$
Turn-On Delay Time	$t_{\text{d(on)}}$	$\text{V}_{\text{DS}}=800\text{V}, \text{V}_{\text{GS}}=-4\text{V}/18\text{V},$ $\text{I}_D=33\text{A}, \text{R}_g=2.5\Omega, \text{R}_L=20\Omega$	—	17	—	ns
Turn-On Rise Time	$t_r$		—	58	—	ns
Turn-Off Delay Time	$t_{\text{d(off)}}$		—	26	—	ns
Turn-Off Fall Time	$t_f$		—	15	—	ns
Turn-On Switching Energy	$\text{E}_{\text{ON}}$	$\text{V}_{\text{DS}}=800\text{V}, \text{V}_{\text{GS}}=-4\text{V}/18\text{V}$ $\text{I}_D=33\text{A}, \text{R}_g=2.5\Omega, \text{L}=100\mu\text{H}$	—	1410	—	$\mu\text{J}$
Turn-Off Switching Energy	$\text{E}_{\text{OFF}}$		—	750	—	$\mu\text{J}$
Internal Gate Resistance	$\text{R}_G$	$f=1\text{MHz}, \text{V}_{\text{AC}}=25\text{mV}$	—	4.9	—	$\Omega$
Total Gate Charge	$\text{Q}_g$	$\text{V}_{\text{DS}}=800\text{V}, \text{I}_D=33\text{A},$ $\text{V}_{\text{GS}}=-4\text{V}/18\text{V}$	—	121	—	$\text{nC}$
Gate-Source Charge	$\text{Q}_{\text{gs}}$		—	34	—	
Gate-Drain Charge	$\text{Q}_{\text{gd}}$		—	20	—	

### Reverse Diode Characteristics

Diode Forward Voltage	$\text{V}_{\text{SD}}$	$\text{V}_{\text{GS}}=-4\text{V}, \text{I}_{\text{SD}}=20\text{A}$	—	4.5	—	V
		$\text{V}_{\text{GS}}=-4\text{V}, \text{I}_{\text{SD}}=20\text{A}, T_j=175^\circ\text{C}$	—	4.2	—	
Continuous Diode Forward Current	$\text{I}_S$	$\text{T}_c=25^\circ\text{C}$	—	—	51	A
Reverse Recover Time	$t_{\text{rr}}$	$\text{V}_{\text{R}}=800\text{V}, \text{I}_{\text{SD}}=33\text{A}$	—	38	—	ns
Reverse Recovery Charge	$\text{Q}_{\text{rr}}$		—	109	—	nc
Peak Reverse Recovery Current	$\text{I}_{\text{rrm}}$		—	5	—	A

## RATING AND CHARACTERISTIC CURVES

Figure.1 Output Characteristics  $T_j=25^\circ\text{C}$

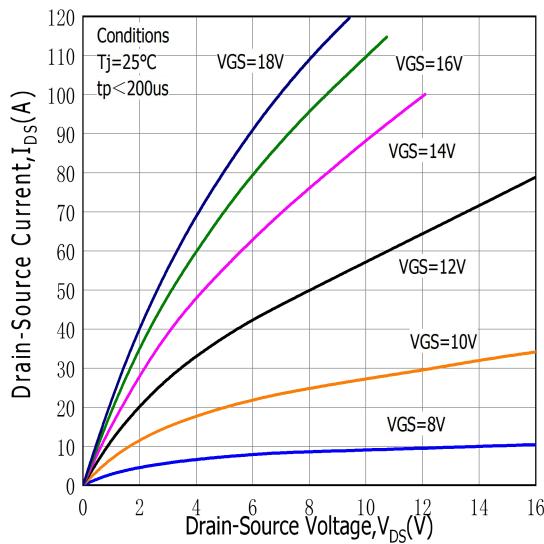


Figure.3 On-Resistance vs.Temperature

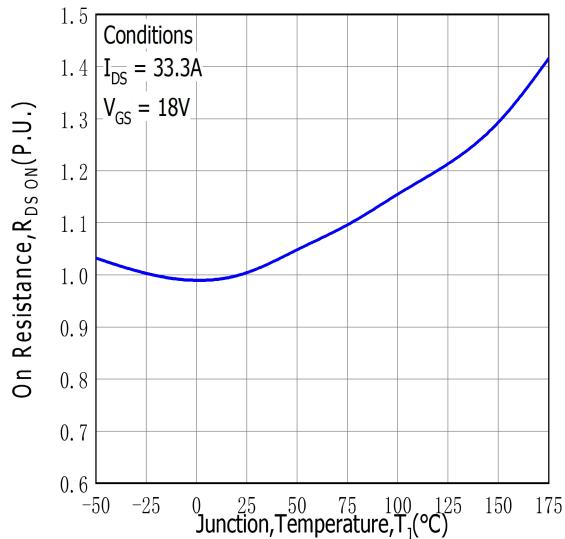


Figure.5 On-Resistance vs.Temperature for Various Gate Voltage

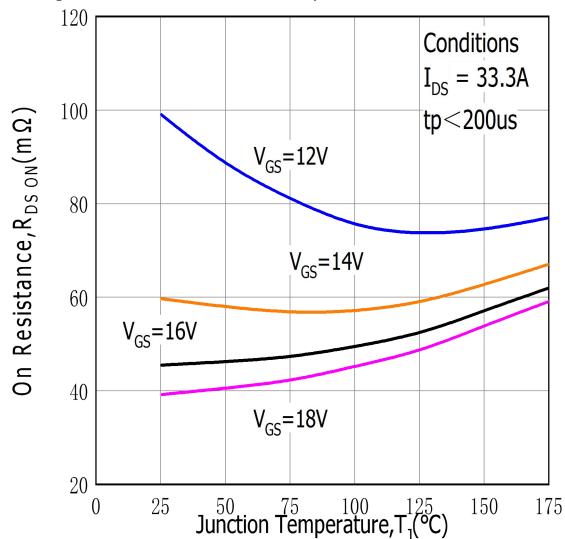


Figure.2 Output Characteristics  $T_j=175^\circ\text{C}$

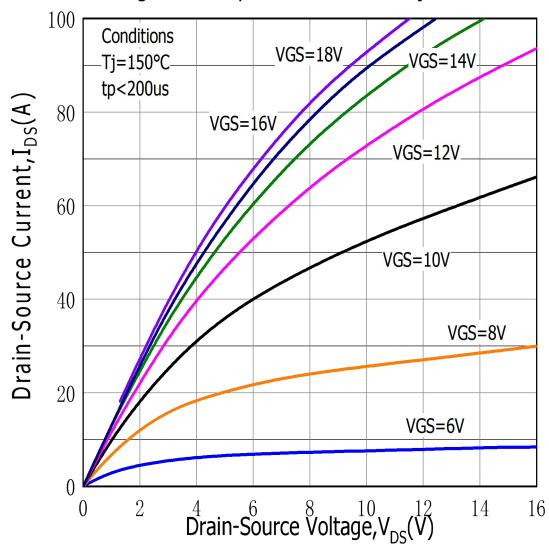


Figure.4 On-Resistance vs.Drain Current for Various Temperatures

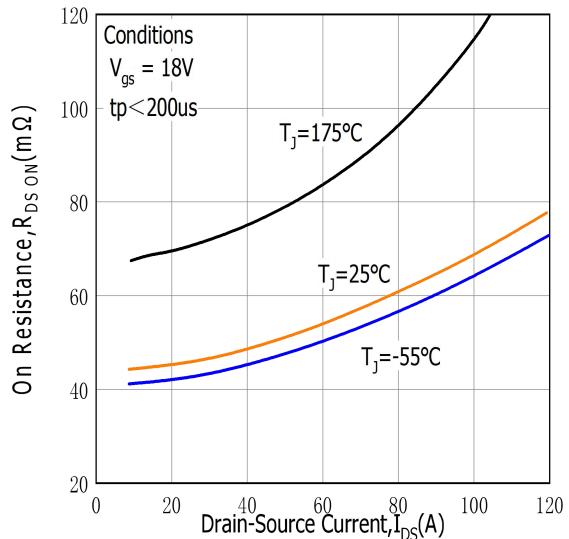


Figure.6 Transfer Characteristic for Various Junction Temperatures

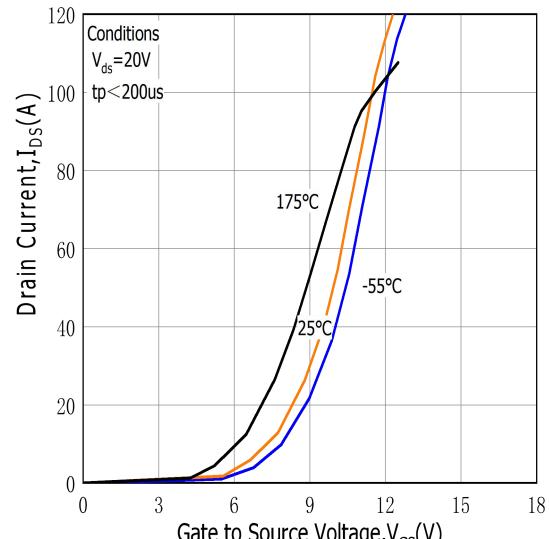


Figure.7 Body Diode Characteristic at 25°C

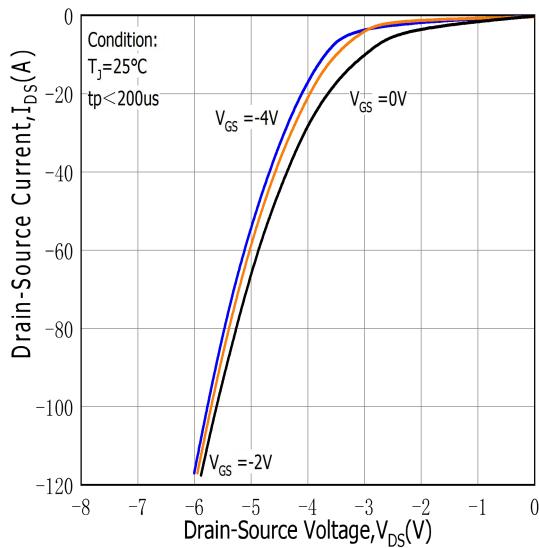


Figure.8 Body Diode Characteristic at 175°C

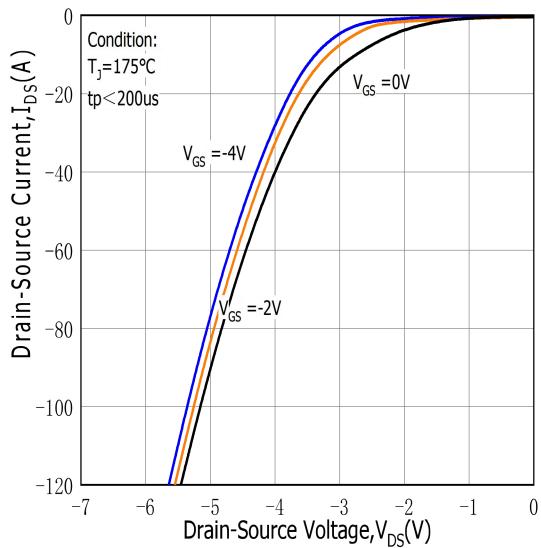


Figure.9 Threshold Voltage vs.Temperature

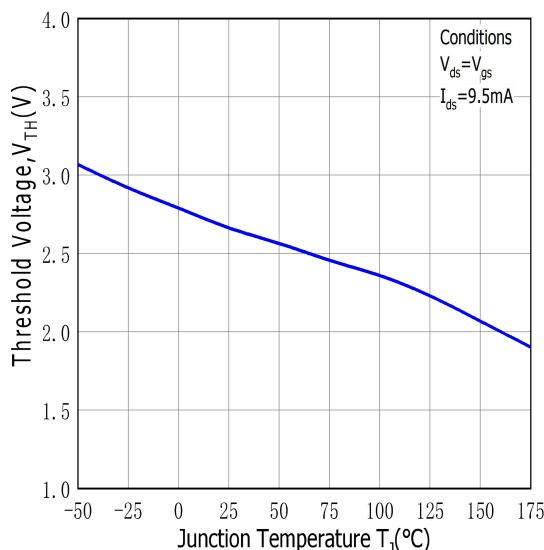


Figure.10 Gate Charge Characteristics

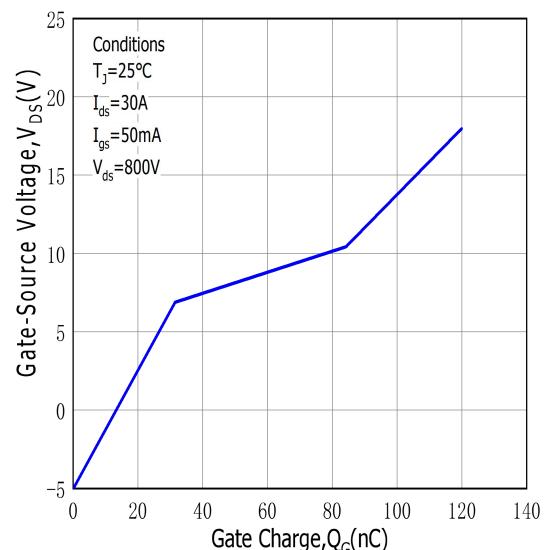


Figure.11 3rd Quadrant Characteristic at 25°C

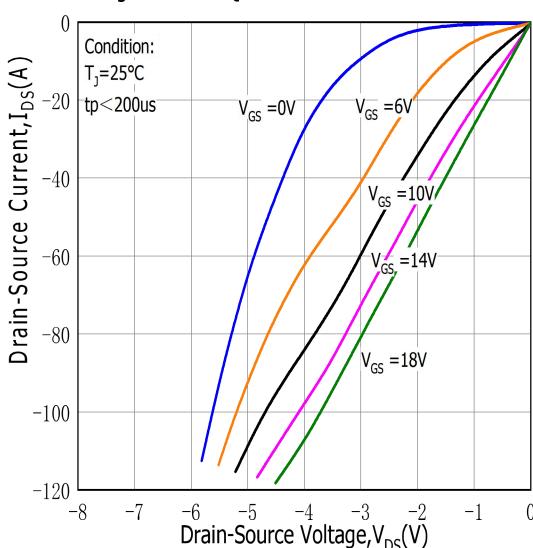


Figure.12 3rd Quadrant Characteristic at 175°C

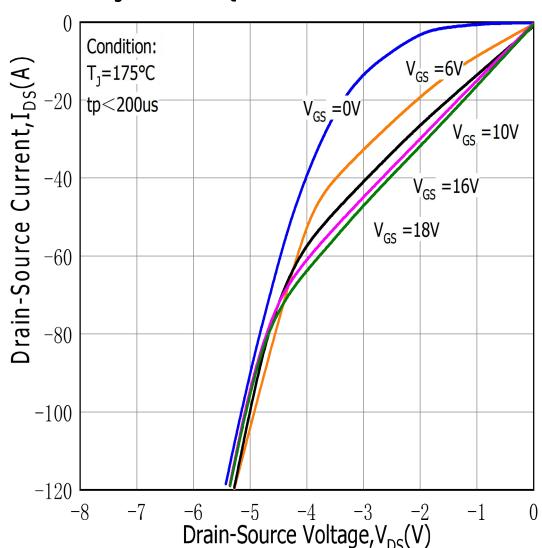


Figure.13 Capacitances vs. Drain-Source Voltage(0-200V)

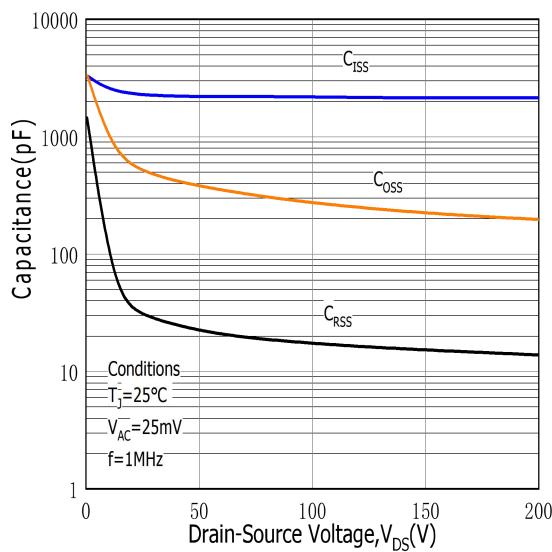
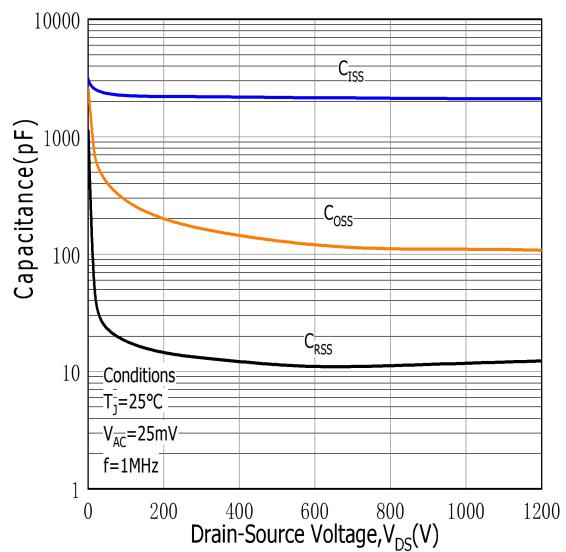
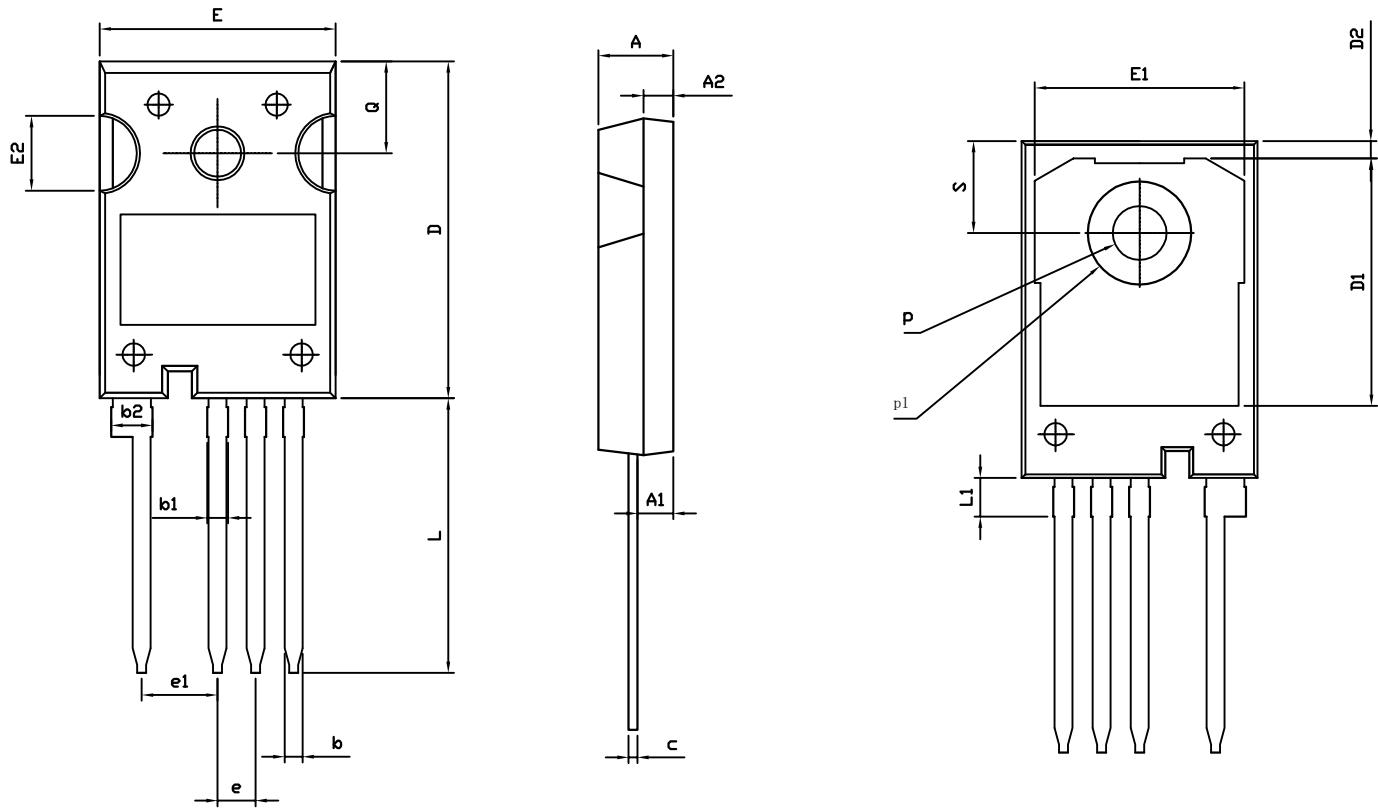


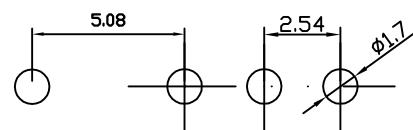
Figure.14 Capacitances vs. Drain-Source Voltage(0-1200V)



# TO-247-4L PACKAGE OUTLINE



## RECOMMENDED LAND PATTERN



UNIT: mm

	MIN	NOM	MAX
A	4.80	5.00	5.20
A1	2.25	2.40	2.45
A2	1.85	2.00	2.15
b	1.05	1.20	1.35
b1	1.00	1.30	1.60
b2	2.35	2.65	2.95
c	0.50	0.60	0.70
D	22.34	22.54	22.74
D1	16.00	16.50	17.00
D2	0.97	1.17	1.37
e	2.34	2.54	2.74
e1	4.88	5.08	5.28
E	15.60	15.80	16.00
E1	13.50	14.00	14.50
E2	4.80	5.00	5.20
L	18.08	18.38	18.68
L1	2.38	2.58	2.78
p	3.50	3.60	3.70
p1	6.60	6.80	7.00
Q	6.00	6.15	6.30
S	6.00	6.15	6.30